## Docket No. \_\_\_\_

## **DECLARATION FOR U.S. PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CONDUCTIVE PASTE FOR CONNECTING THERMOELECTRIC CONVERSION MATERIAL

the specification	n of which is attached hereto u	nless the following is chec	ked .	
	aas United States Applic pplication Number PCT/JP200			2004 as PCT
I hereby state the claim(s), as amount	nat I have reviewed and unders ended by any amendment refer	tand the contents of the abored above.	ove-identified specification,	including the
I acknowledge Regulations, §	the duty to disclose information 1.56.	n which is material to pate	ntability as defined in Title 3	37, Code of Federal
for patent or inv	foreign priority benefits under ventor's certificate listed below ficate having a filing date before	and have also identified b	elow any foreign application	eign application(s) n for patent or
۴.				<b>Priority Claimed</b>
(List prior foreign				
applications. See note A)	2003-348913	Japan	08/10/2003	🛛 Yes 🗌 No
110101.1)	(Number)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				🗌 Yes 🔲 No
	(Number)	(Country)	(Day/Month/Year Filed)	
	` ,	` '		
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Ween Filed)	
	· · ·	`	(Day/Month/Year Filed)	
(See note B)	See attached list for additional	l prior foreign applications		ز
insofar as the si in the manner p information wh	the benefit under Title 35, Uni ubject matter of each of the cla provided by the first paragraph ich is material to patentability ecame available between the fi lication.	ims of this application is n of Title 35, United States as defined in Title 37, Cod	not disclosed in the prior Units Code, § 112, I acknowledgued to of Federal Regulations,	ited States application to the duty to disclose
			Stat	us
(List prior U.S. Applications)			☐ Patented ☐ Pending ☐ Abandoned	
	(Application Serial No.)	(Filing Date)		
	(Application Serial No.)	(Filing Date)	☐ Patented ☐ Pend	ling   Abandoned
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	(Application ocital 140.)	(LIME Daic)		

Lhereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

## **Customer Number: 38834**

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or f Inventor's signature	irst inventor (given name, f	T • // //		ASHI Ryoji
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		Osaka 5638577, Japan			Aut
	Full name of second i Inventor's signature	nventor (given name, famil	y name)	Date	
	Residence			Citizenship	
	Post Office Address			Chizenship	
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	Full name of third inv	entor (given name, family r	iame)	<u> </u>	
	Inventor's signature			Date	
	Residence Post Office Address			Citizenship	
	Post Office Address				
		<u> </u>			
	Full name of fourth in	oventor (given name, family	name)		
	Inventor's signature			Date	
	Residence			Citizenship	
	Post Office Address				
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	Full name of fifth inv	entor (given name, family n	ame)		
	Inventor's signature			Date	
	Residence			Citizenship	
	Post Office Address				
			_		
	Full name of sixth inventor (given name, family name)				
	Inventor's signature			Date	
	Residence			Citizenship	
	Post Office Address				